



P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
- 12	0.032 at V _{GS} = - 4.5 V	- 5.3		
	0.042 at V _{GS} = - 2.5 V	- 4.6		
	0.059 at V _{GS} = - 1.8 V	- 3.9		

FEATURES

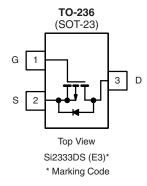
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET





APPLICATIONS

- Load Switch
- PA Switch



Ordering Information: Si2333DS-T1-E3 (Lead (Pb)-free) Si2333DS-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T	_A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 12		V
Gate-Source Voltage		V _{GS}	± 8		
Continuous Drain Current (T _J = 150 °C) ^{a, b}	T _A = 25 °C	- I _D	- 5.3	- 4.1	A
Continuous Drain Current (1) = 150 °C)	T _A = 70 °C		- 4.2	- 3.3	
Pulsed Drain Current		I _{DM}	- 20		А
Continuous Source Current (Diode Conduction) ^{a, b}		I _S	- 1.0 - 0.6		
	T _A = 25 °C	- P _D	1.25	0.75	w
Maximum Power Dissipation ^{a, b}	T _A = 70 °C		0.8	0.48	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manipulation to Applicate	t ≤ 5 s	- R _{thJA}	75	100	°C/W
Maximum Junction-to-Ambient ^a	Steady State		120	166	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	40	50	

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Pulse width limited by maximum junction temperature.

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	1		Limits			1	
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 12			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	- 0.40		- 1.0	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 9.6 V, V _{GS} = 0 V			- 1		
		$V_{DS} = -9.6 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 V$, $V_{GS} = -4.5 V$	- 20			Α	
		V _{GS} = - 4.5 V, I _D = - 5.3 A		0.025	0.032		
Drain-Source On-Resistance ^a	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D = -4.6 \text{ A}$		0.033	0.042		
	` ′	V _{GS} = - 1.8 V, I _D = - 2.0 A		0.046	0.059		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 5 V, I _D = - 5.3 A		17		S	
Diode Forward Voltage	V_{SD}	I _S = - 1.0 A, V _{GS} = 0 V		- 0.7	- 1.2	V	
Dynamic ^b			•	•	•		
Total Gate Charge	Q_g			11.5	18	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}$ $I_{D} \cong -5.3 \text{ A}$		1.5			
Gate-Drain Charge	Q_{gd}	ID = - 3.3 A		3.2		1	
Input Capacitance	C _{iss}			1100			
Output Capacitance	C _{oss}	$V_{DS} = -6 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		390		pF	
Reverse Transfer Capacitance	C _{rss}			300			
Switching ^c	1			1			
Turn-On Time	t _{d(on)}			25	40		
	t _r	$V_{DD} = -6 \text{ V}, R_L = 6 \Omega$ $I_D \cong -1.0 \text{ A}, V_{GEN} = -4.5 \text{ V}$		45	70]	
T 0# Time	t _{d(off)}			72	110	ns	
Turn-Off Time	t _f	g - 2 2 2		60	90		

Notes:

- a. Pulse test: PW \leq 300 μ s, duty cycle \leq 2 %.
- b. For design aid only, not subject to production testing.
- c. Switching time is essentially independent of operating temperature.

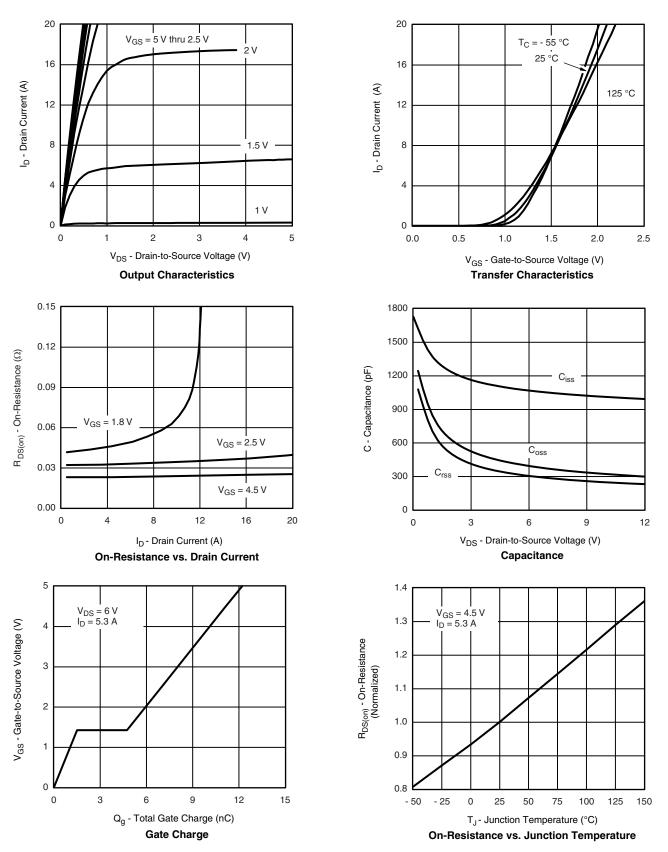
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.







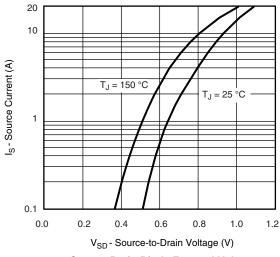
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

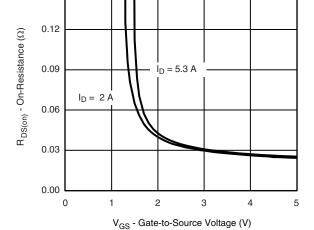


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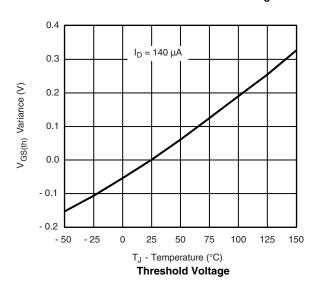


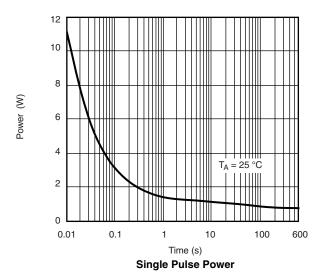


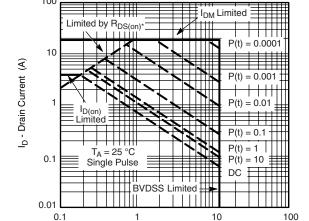
0.15

Source-Drain Diode Forward Voltage





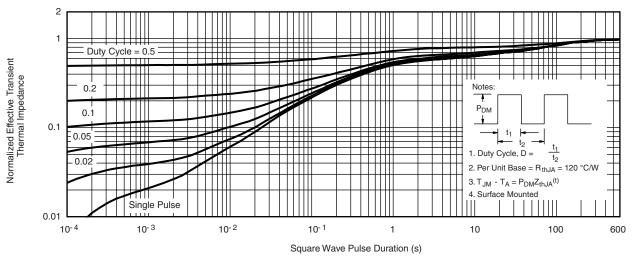




 $\label{eq:VDS} V_{DS} - Drain-to-Source Voltage (V) $$^*V_{GS}$ > minimum V_{GS} at which $R_{DS(on)}$ is specified $$ \textbf{Safe Operating Area}$$$



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Normalized Thermal Transient Impedance, Junction-to-Ambient

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